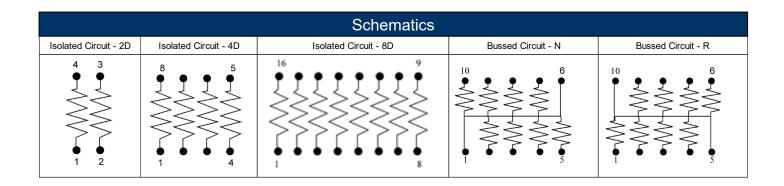
#### Features:

- Thick film resistor element
- Multiple circuit types available
- Ideal SMD substitute for leaded networks
- Auto-placement capability
- Square corner construction standard
- Zero-ohm jumper available
- RAVF 324D is standard with scalloped corner
- Styles 102D, 104D and 164D are qualified to AEC-Q200
- 100% RoHS compliant and lead free without exemption
- Halogen free
- REACH compliant

332	332
332	332

Electrical Specifications						
Type/Code, # of Elements,	Power Rating (W) (per element)	Maximum Working Voltage	Maximum Overload	TCR (ppm/⁰C)	Ohmic Range ( $\Omega$ ) and Tolerance	
Circuit Type	© @ 70°C	(V) <sup>(1)</sup>	Voltage (V)		1%	2%, 5%
	0.063	25	50	± 400	-	1 - 9.1
RAVF102D	0.003	25	50	± 200	10 -	1M
	Jumper: 1A				0.025 max	0.05 max
	0.063	05	50	± 400	-	1 - 9.1
RAVF104D	0.003	25	50	± 200	10 - 1M	
	Jumper: 1A				0.025 max	0.05 max
RAVF162D	0.063	50	100	± 200	10 - 1M	1 - 1M
	Jumper: 1A			-	-	0.05 max
	0.1	50	100	± 400	-	1 9.1
RAVF164D	0.1			± 200	10 - 1M	10 - 1M
	Jumper: 1A				0.025 max	0.05 max
	0.063	0.063 25	50	± 250	-	1 - 1M
RAVF168D	0.003			± 200	10 - 1M	-
	Jumper: 1A			-	-	0.05 max
RAVF324D	0.125	200	400	± 200	22 - 1M	10 - 1M
RAVF328N	0.063	25	50	± 200	-	22 - 1M
RAVF328R	0.063	25	50	± 200	-	22 - 1M

(1) Lesser of  $\sqrt{P^*R}$  or maximum working voltage.

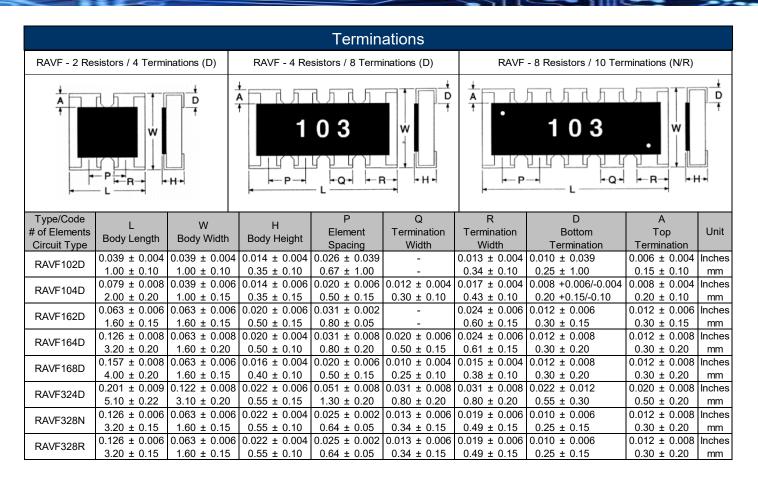


Downloaded from Arrow.com.

1

# Stackpole Electronics, Inc.

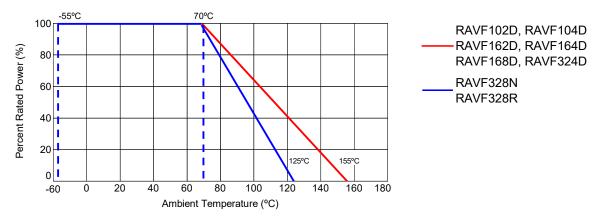
**Resistive Product Solutions** 



Performance Characteristics					
Test Test Result (JIS C 5202)					
Load Life in Moisture ±3%					
Temperature cycle	±1%				
Load Life	±3%				
Resistance to Soldering heat ±1%					
Terminal Adhesion	±1%				
Short Time Overload	±2%				

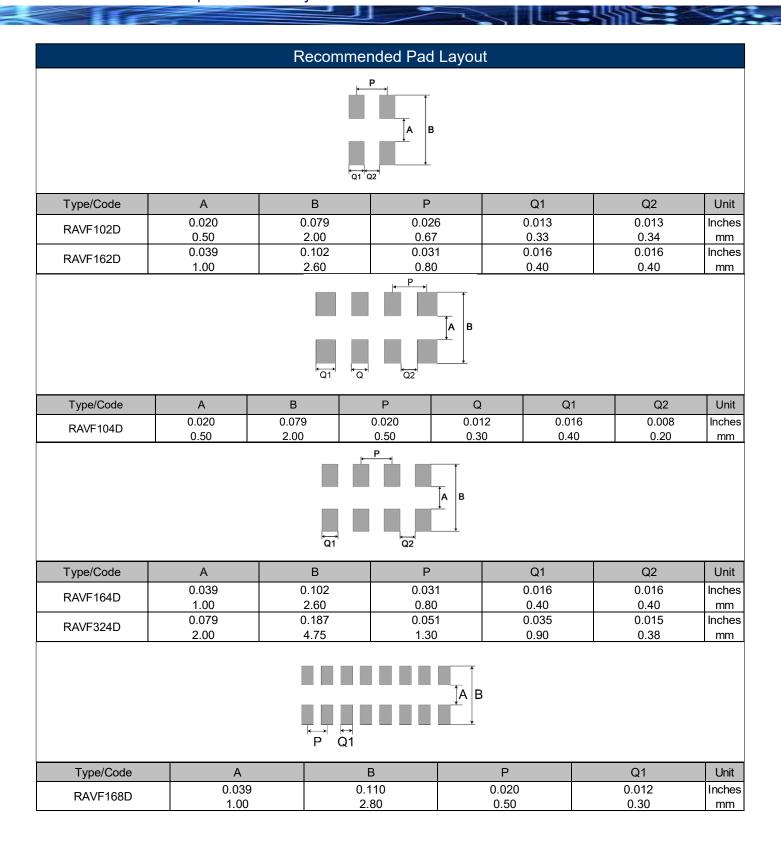
Operating temperature range is -55°C to +155°C, except for RAVF328N and RAVF328R Operating temperature range for RAVF328N and RAVF328R is -55°C to +125°C

#### Power Derating Curve:



## Rev Date: 7/30/2021

2



Downloaded from Arrow.com.

Recommended Pad Layout (cont.)							
Type/Code	А	В	Р	Q1	Q2	Unit	
RAVF328R	0.031 0.80	0.122 3.10	0.025 0.64	0.013 0.34	0.018 0.45	Inches mm	

# **Recommended Solder Profile**

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "\*".

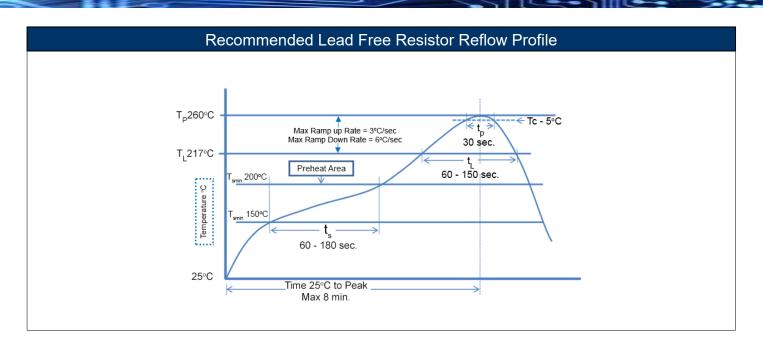
## 100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

Wave Soldering						
Description Maximum Recommended Minimum						
Preheat Time	80 seconds	70 seconds	60 seconds			
Temperature Diff.	140°C	120°C	100°C			
Solder Temp.	260°C	250°C	240°C			
Dwell Time at Max.	10 seconds	5 seconds	*			
Ramp DN (°C/sec)	N/A	N/A	N/A			

Temperature Diff. = Defference between final preheat stage and soldering stage.

Convection IR Reflow							
Description Maximum Recommended Minimum							
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*				
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds				
Solder Temp.	260°C	245°C	*				
Dwell Time at Max.	30 seconds	15 seconds	10 seconds				
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*				



#### RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
RAVF	Thick Film Surface Mount Chip Resistor Array Convex Terminations	SMD	YES(1)	100% Matte Sn over Ni	Jan-04 (Japan) Jul-04 (Taiwan)	04/01 04/27

Note (1): RoHS Compliant by means of exemption 7c-I.

This specification may be changed at any time without prior notice

## "Conflict Metals" Commitment

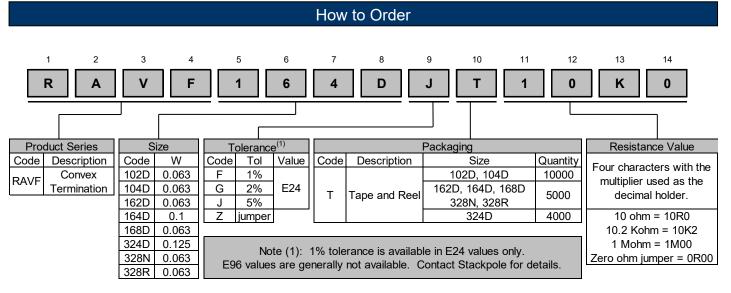
We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

## Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

#### **Environmental Policy**

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.



D = Isolated

N = Bussed

R = Bussed